

PATENT NUMBER

U.S. **UTILITY** Patent Application

<p> (2) RAW SCANNED <u>55</u> Q.A. <u>Omni</u> </p>	<p> O.I.P.E. PATENT DATE </p>
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CLASS 2567	SUBCLASS 783	ART UNIT 2827	EXAMINER Kotter
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APPLICATION NO. 09/484437	CONT/PRIOR YES	CLASS 35	SUBCLASS 361	ART UNIT 2835	EXAMINER [Signature]
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S Tongbi Jiang

APPLICANTS

Die attach curing method for semiconductor device

TITLE

ISSUING CLASSIFICATION

[illegible]PTO-2040
12/99

<input type="checkbox"/> TERMINAL DISCLAIMER	DRAWINGS			CLAIMS ALLOWED	
	Sheets Drwg.	Figs. Drwg.	Print Fig.	Total Claims	Print Claim for O.G.
<input type="checkbox"/> The term of this patent subsequent to _____ (date) has been disclaimed. <input type="checkbox"/> The term of this patent shall not extend beyond the expiration date of U.S Patent. No. _____ _____ _____	_____ (Assistant Examiner) (Date)			NOTICE OF ALLOWANCE MAILED	
	_____ (Primary Examiner) (Date)			ISSUE FEE	
Amount Due				Date Paid	
<input type="checkbox"/> The terminal ____ months of this patent have been disclaimed.	_____ (Legal Instruments Examiner) (Date)			ISSUE BATCH NUMBER	
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